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2.626 Fundamentals of Photovoltaics
Fall 2008

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Wafer Silicon-Based PV

Lecture 9 – 2.626

Tonio Buonassisi

General Announcements

- Quiz #1
- Class Projects

Outline of Today's Lecture

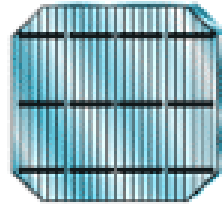
- Illuminated IV Curves: Efficiency, J_{sc} , V_{oc}
- Notes about Efficiency
- Overview of PV Technologies
- Manufacturing of Silicon-Based Solar Cells

Image removed due to copyright restrictions. Please see <http://solarpowerindustries.com/Images/silicon-feedstock.jpg>

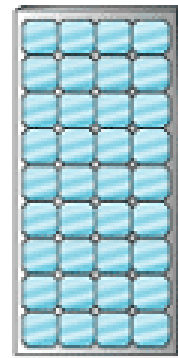
Feedstock



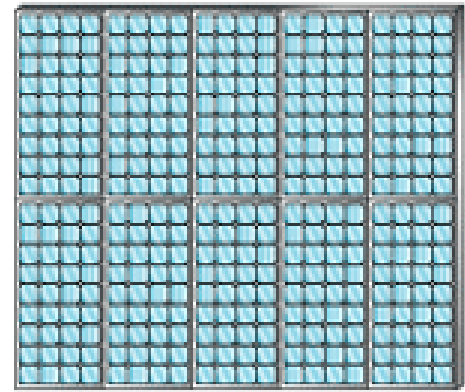
Wafer



Cell



Module



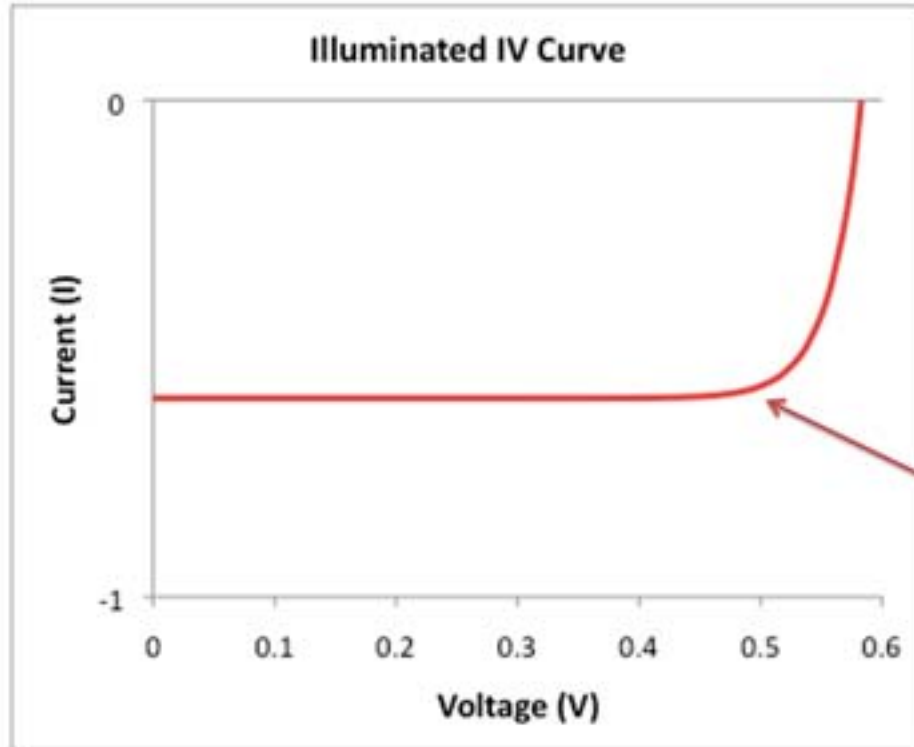
Array

Courtesy NASA and EERE.

Reading Assignment

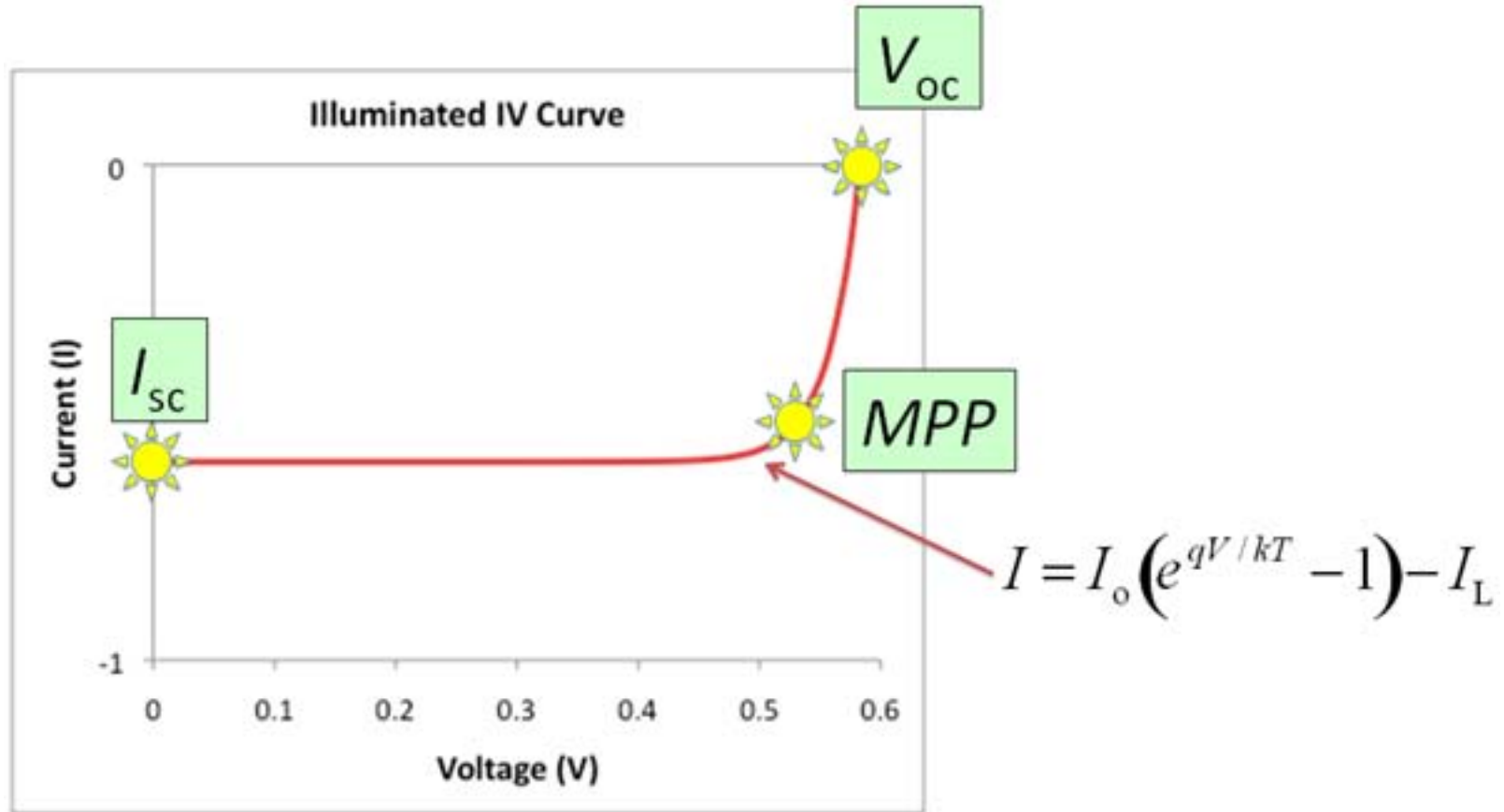
- Read: PVCDROM: Chapters 5 and 6

Efficiency Calculations



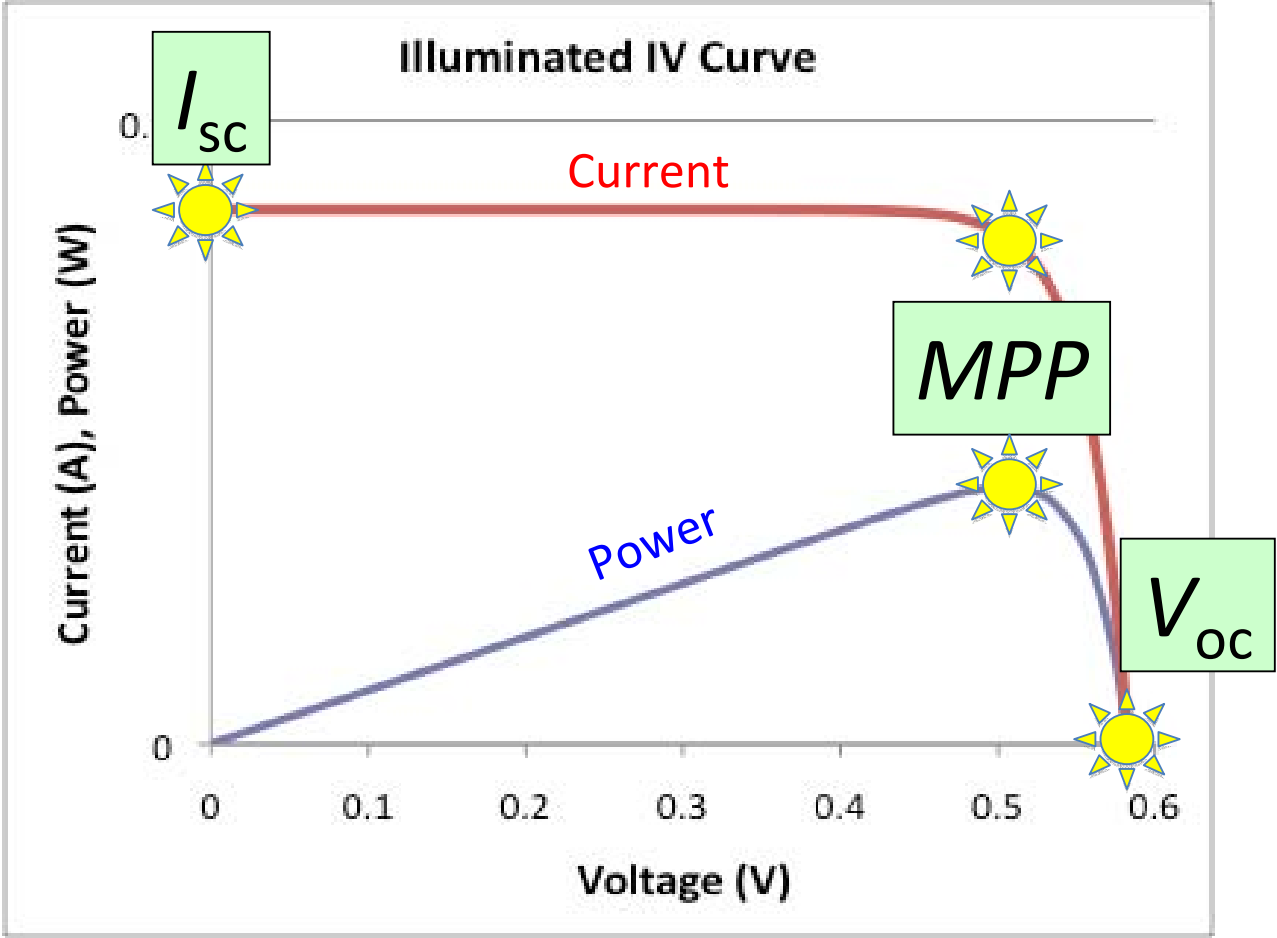
$$I = I_o \left(e^{qV/kT} - 1 \right) - I_L$$

Efficiency Calculations

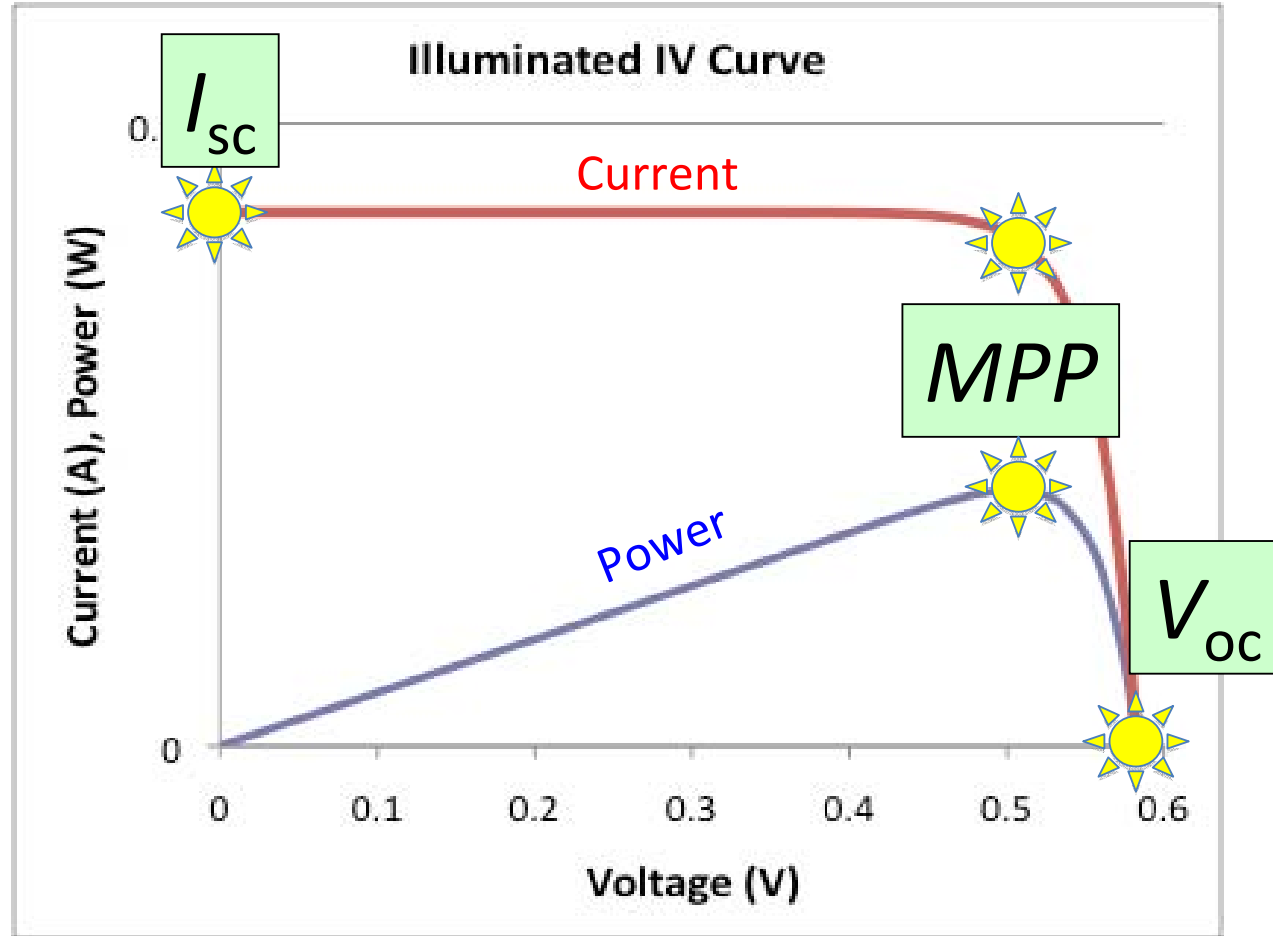


Efficiency Calculations

Industry Convention: Quadrant flipped!

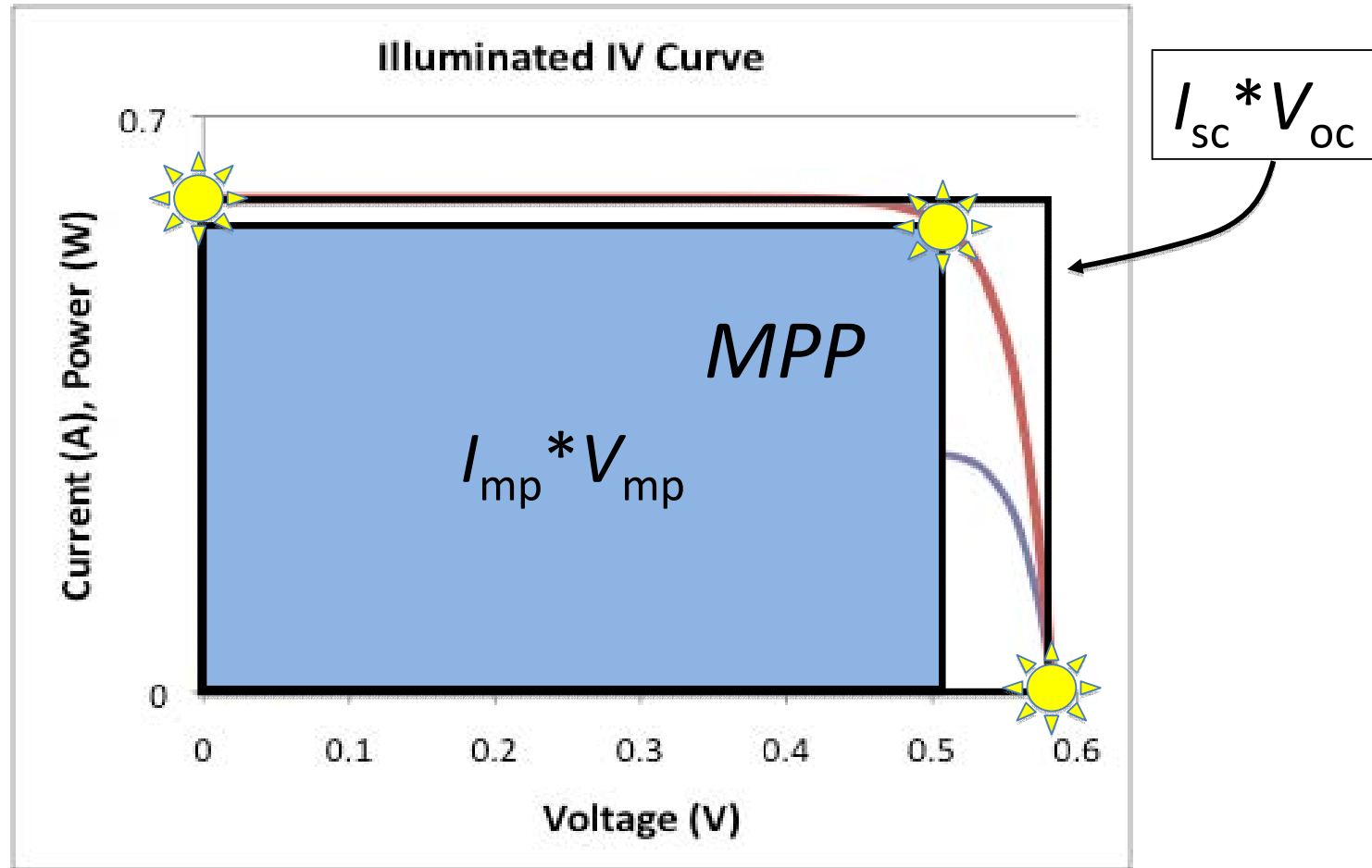


Efficiency Calculations



$$\text{Efficiency} \equiv \eta = \frac{\text{Power Out}}{\text{Power In}} = \frac{V_{mp} \cdot I_{mp}}{\Phi}$$

Efficiency Calculations



$$\text{Fill Factor} \equiv FF = \frac{V_{mp} \cdot I_{mp}}{V_{oc} \cdot I_{sc}}$$

Efficiency Calculations

By combining equations 1 and 2...

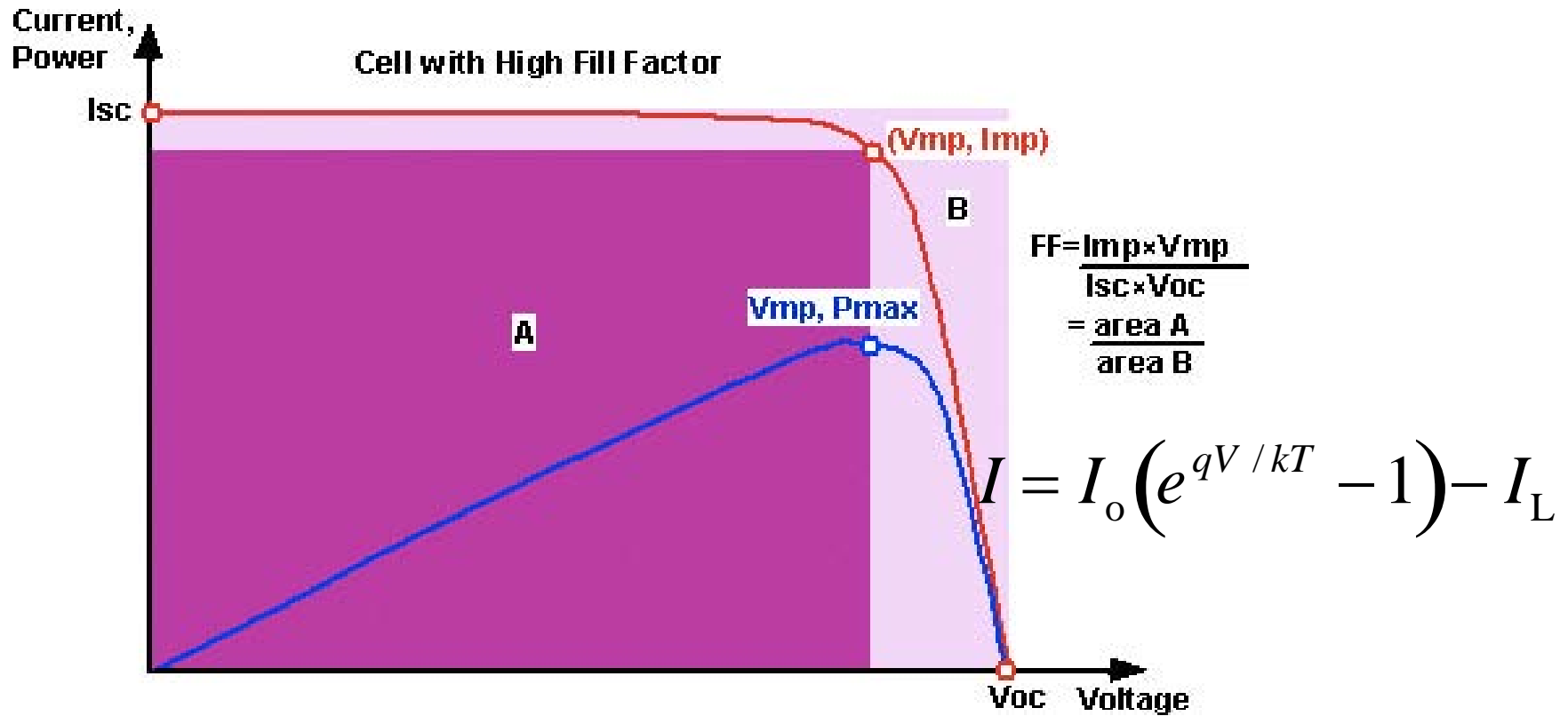
$$\text{Efficiency} \equiv \eta = \frac{\text{Power Out}}{\text{Power In}} = \frac{V_{\text{mp}} \cdot I_{\text{mp}}}{\Phi}$$

$$\text{Fill Factor} \equiv FF = \frac{V_{\text{mp}} \cdot I_{\text{mp}}}{V_{\text{oc}} \cdot I_{\text{sc}}}$$

We obtain:

$$\text{Efficiency} \equiv \eta = \frac{\text{Power Out}}{\text{Power In}} = \frac{V_{\text{mp}} \cdot I_{\text{mp}}}{\Phi} = \frac{FF \cdot V_{\text{oc}} \cdot I_{\text{sc}}}{\Phi}$$

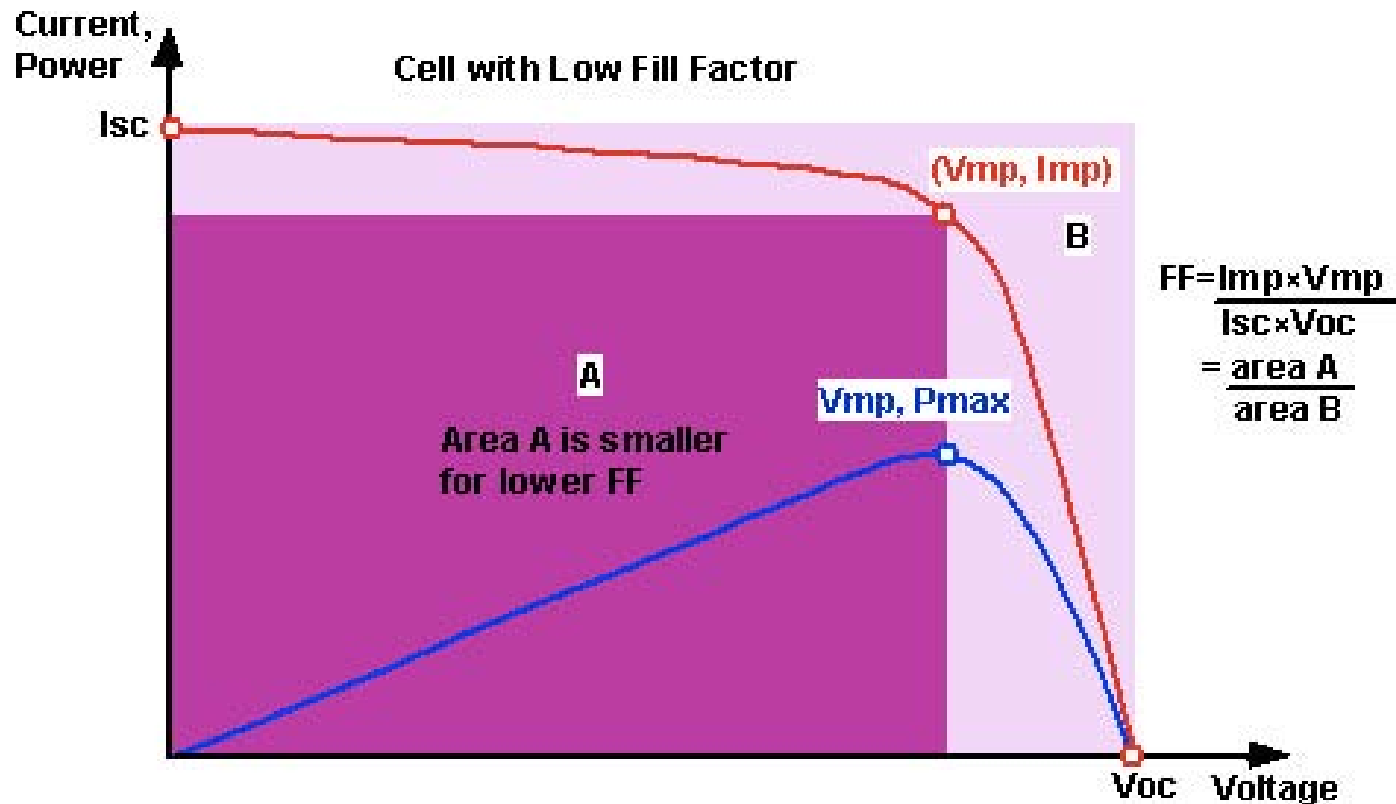
Efficiency Calculations



Courtesy Christiana Honsberg and Stuart Bowden. Used with permission.

This is a higher-efficiency device compared to... [next slide]

Efficiency Calculations



Courtesy Christiana Honsberg and Stuart Bowden. Used with permission.

This is a lower-efficiency device, compared to the previous slide.

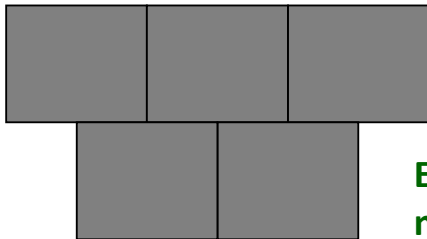
Efficiency of a solar cell is an important parameter

$$\eta = \frac{\text{generated electrical power}}{\text{incident light power}}$$

100% efficiency
(impossible to achieve)

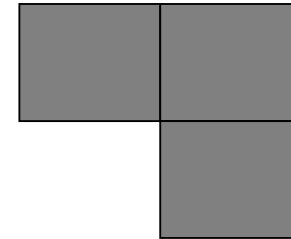


20% efficiency
(monocrystalline
silicon solar cells)



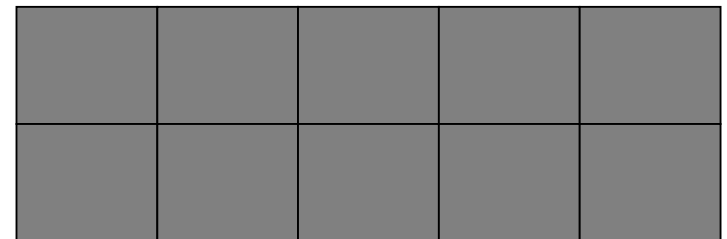
Expensive
material

33% efficiency
(space-grade solar cells)



Very
Expensive
material

10% efficiency
(amorphous
silicon solar cells)



Relatively Inexpensive material

A Note about “Efficiency”

LETTERS

Solution-processed PbS quantum dot infrared photodetectors and solar cells

What does this
really mean?

Under -5 V bias and illumination from a 975 nm laser, our detectors show an internal quantum efficiency of 3%, a ratio of photocurrent to dark current of 630, and a maximum responsivity of 3.1×10^{-3} A W $^{-1}$. The photovoltaic response under 975 nm excitation results in a maximum open-circuit voltage of 0.36 V, short-circuit current of 350 nA, and short-circuit internal quantum efficiency of 0.006%.

Technical Terms:

- Solar Conversion Efficiency
- External Quantum Efficiency
- Internal Quantum Efficiency

Courtesy of Edward H. Sargent. Used with permission.

Solar Conversion Efficiency

$$\eta = \frac{\text{Power Out}}{\text{Power In}} = \frac{J_{\text{mp}} \cdot V_{\text{mp}}}{\Phi} = \frac{\text{FF} \cdot J_{\text{sc}} \cdot V_{\text{oc}}}{\Phi}$$

Typical values are 12–20% for established technologies, <10% for most emerging technologies.

η and Φ_{f} : Vary with illumination intensity (e.g., 1 Sun)

External Quantum Efficiency

$$\text{EQE} = \frac{\text{Electrons Out}}{\text{Photons In}}$$

Typical peak values are 60–90%, depending on reflectivity.

EQE highly wavelength- and illumination-dependent!

Internal Quantum Efficiency

$$\text{IQE} = \frac{\text{Electrons Out}}{(\text{Photons In}) \cdot (1 - \text{Reflectivity})}$$

Typical peak values are 80–98%, depending on reflectivity.

EQE highly wavelength- and illumination-dependent!

When an efficiency quoted, think about:

- What “efficiency” is being measured?
- What is the nature of the light being used?
 - What spectrometer to simulate solar spectrum?
 - If monochromatic, what wavelength?
 - What intensity (photon flux)?
- What used car are they trying to sell me?

An example of honest efficiency reporting

Text removed due to copyright restrictions. Please see the Abstract of Huynh, Wendy U., Janke J. Dittmer, and A. Paul Alivisatos. "Hybrid Nanorod-Polymer Solar Cells." *Science* 295 (March 29, 2002): 2425-2427.

W.U. Huynh, *Science* **295** (2002) 2425

Solar Cell Efficiency Tables

Table removed due to copyright restrictions. Please see Table I in
Green, Martin A., et al. "Solar Cell Efficiency Tables (Version 27)."
Progress in Photovoltaics: Research and Applications 14 (2006): 45-51.

Module Efficiency Tables

Table removed due to copyright restrictions. Please see Table II in
Green, Martin A., et al. "Solar Cell Efficiency Tables (Version 27)."
Progress in Photovoltaics: Research and Applications 14 (2006): 45-51.

M.A. Green, *Prog. Photovolt: Res. Appl.* **14** (2006) 45

Diversity of PV Devices

Photovoltaic Device Fundamentals

(1) Charge Generation: Light excites electrons, freeing them from atomic bonds and allowing them to move around the crystal.

(3) Charge Collection: Electrons deposit their energy in an external load, complete the circuit.

(2) Charge Separation: An electric field engineered into the material (pn junction) sweeps out electrons.

Advantages: There are no moving parts and no pollution created at the site of use (during solar cell production, that's another story).

Disadvantages: No output at night; lower output when weather unfavorable.

Image removed due to copyright restrictions. Please see <http://micro.magnet.fsu.edu/primer/java/solarcell/>

For full animation, see:

<http://micro.magnet.fsu.edu/primer/java/solarcell/>

Technological Diversity

http://peswiki.com/images/8/86/Spherical_solar_panel_95x95.jpg

Fig. 1 in Takamoto, Tatsuya, et al.
"Over 30% efficient InGaP/GaAs
tandem solar cells." *Applied Physics
Letters* 70 (January 20, 1997): 381-
383.

<http://site.novatechgadgets.com/evtechfeat.jpg>

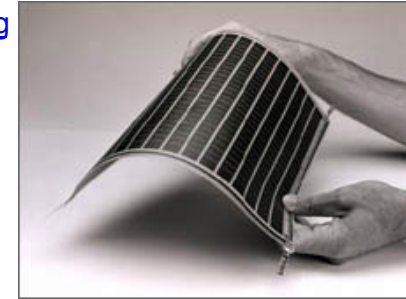
<http://www.stangl.de/typo3temp/pics/691aeb319e.jpg>

Silicon Ribbon

Heterojunction
Cells

Copper Indium
Diselenide (CIS)

Spherical
Solar



Courtesy EERE.

Amorphous Silicon

<http://www.atp.nist.gov/eao/sp950-1/astropw1.jpg>

<http://www.ajeal.net/english/wp-content/uploads/solar-panel-cost.jpg>

<http://www.iea-pvps.org/ar/ar00/images/aus03.jpg>

Dye-sensitized
Cells

Silicon Sheet

Cadmium
Telluride

<http://www.triplepundit.com/nanosolar.jpg>

Hybrid (nano)



Courtesy NASA.

Monocrystalline
Silicon

http://commons.wikimedia.org/wiki/File:Multicrystallinewafer_0001.jpg

http://electronicdesign.com/Files/29/11527/Figure_01.jpg

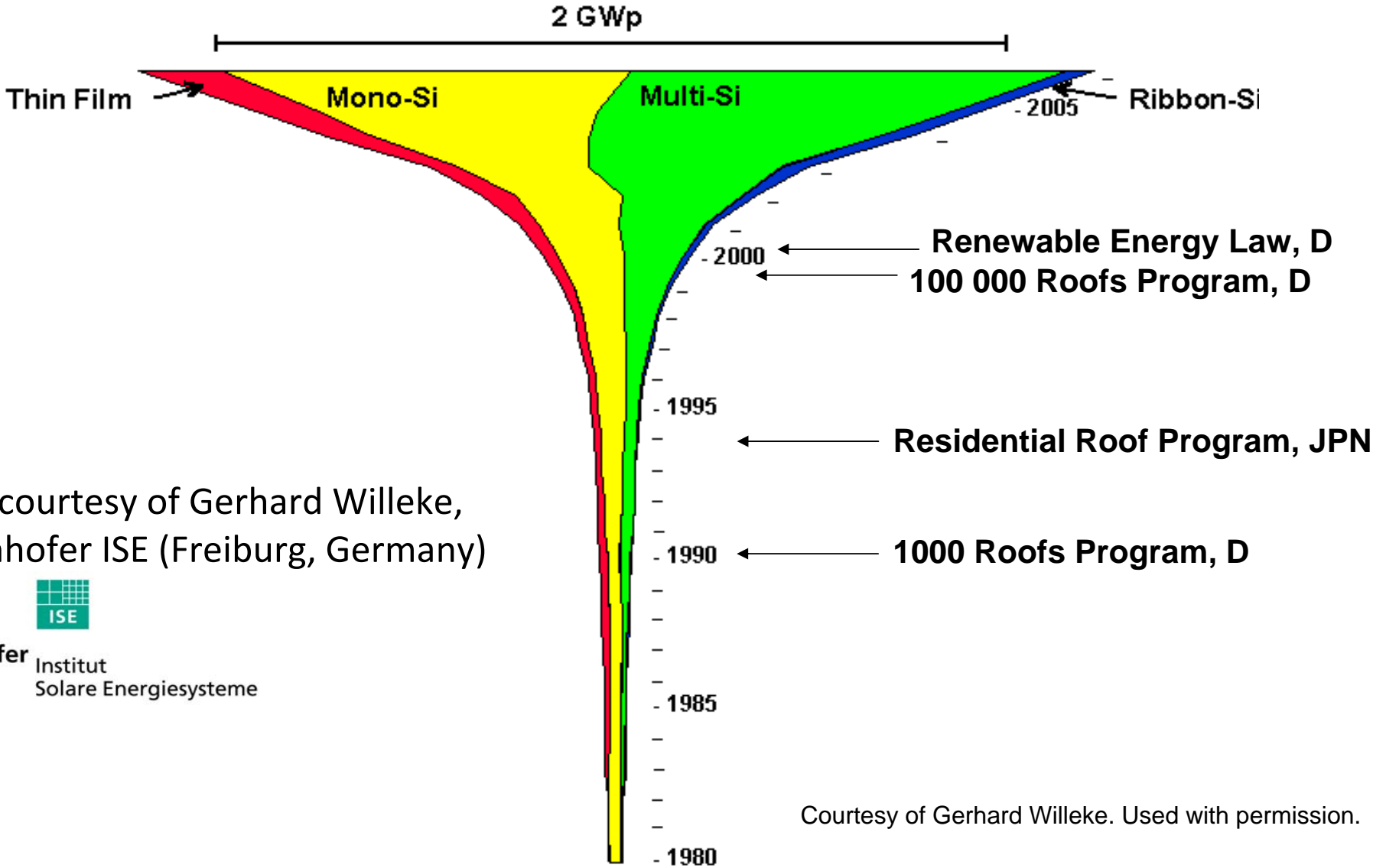
Multicrystalline
Silicon

SunPower
Back-contacted

http://www.livescience.com/images/0412_solar_panels_03.jpg

Organics

Photovoltaics: State of the Art



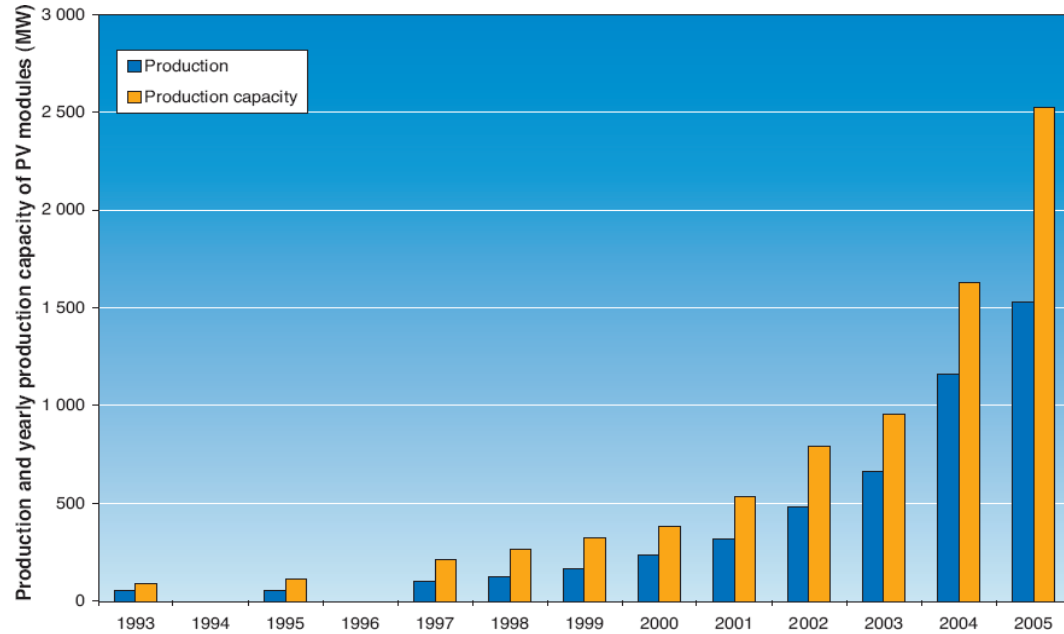
Slide courtesy of Gerhard Willeke, Fraunhofer ISE (Freiburg, Germany)



Courtesy of Gerhard Willeke. Used with permission.

Silicon Photovoltaics – Wafer Substrates

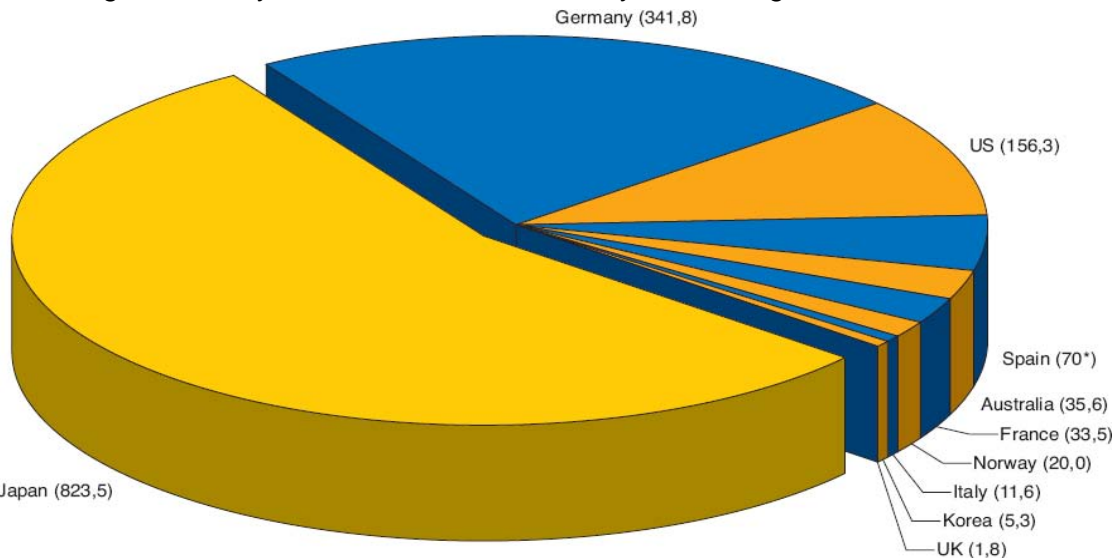
Worldwide PV Production



- Sustained 25-40% industry growth rates.
- PV now a \$10+ bi industry.

IEA-PVPS, Report IEA-PVPS T1-15:2006

Images courtesy IEA Photovoltaic Power Systems Programme.



US Market Share:

1980: 75%

1990: 33%

2000: 26%

2005: 10%

PV News, PV Insider's Report, Feb. 2001

IEA-PVPS: Report IEA-PVPS T1-15:2006

Silicon is the second most abundant element on Earth after oxygen (28% of the Earth's crust). Its most familiar forms are sand and quartzite (the latter one is more pure).

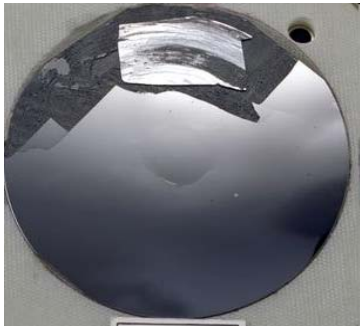
Silicon in Nature: It's everywhere!

http://commons.wikimedia.org/wiki/File:Third_beach_sand.jpg



Human-made Monocrystalline Silicon

http://people.seas.harvard.edu/~jones/es154/lectures/lecture_2/materials/Czochralski_1.gif



Monocrystalline
Silicon

Human-made Multicrystalline Silicon

http://www.tkx.co.jp/english/solar/images/index_img_03.jpg

http://www.tkx.co.jp/english/solar/images/index_img_05.jpg

http://commons.wikimedia.org/wiki/File:Multicrystallinewafer_0001.jpg

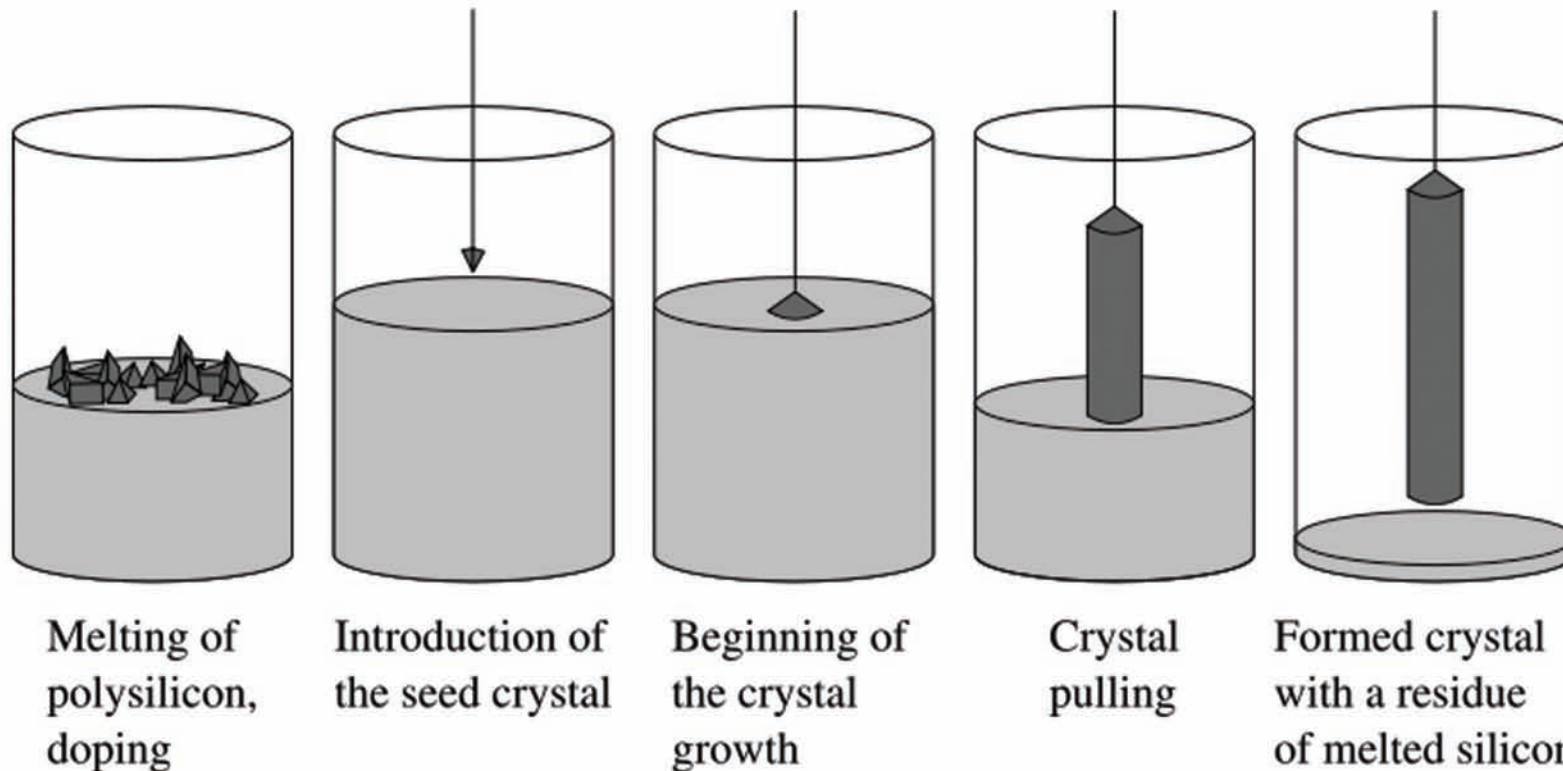
Multicrystalline
Silicon

Crystalline silicon growth technologies used in PV

- ◆ Single crystalline ingot growth
(*Czochralski (CZ) and float zone (FZ) technologies*)
→ *Sunpower, Siemens Solar*
- ◆ Casting of multicrystalline silicon
· - *Sharp, Kyocera, BP Solar, Shell Solar*
- ◆ Ribbon growth of multicrystalline silicon
→ *Evergreen,
RWE Schott Solar (former ASE Americas)*
- ◆ Sheet growth of multicrystalline silicon
→ *General Electric (former Astropower),
ECN*

Czochralski (CZ) crystal growth

1916, Polish physicist Jan Czochralski



Melting of polysilicon, doping

Introduction of the seed crystal

Beginning of the crystal growth

Crystal pulling

Formed crystal with a residue of melted silicon

Si melting point 1414°C

Growth rate approx. 5 cm/hour

Typical crystal size:
10-30 cm in diameter,
1-2 meters long

This type of silicon is the standard for integrated circuit industry. Very high quality ingots. Partial dissolution of quartz crucible introduces oxygen and carbon into the melt.

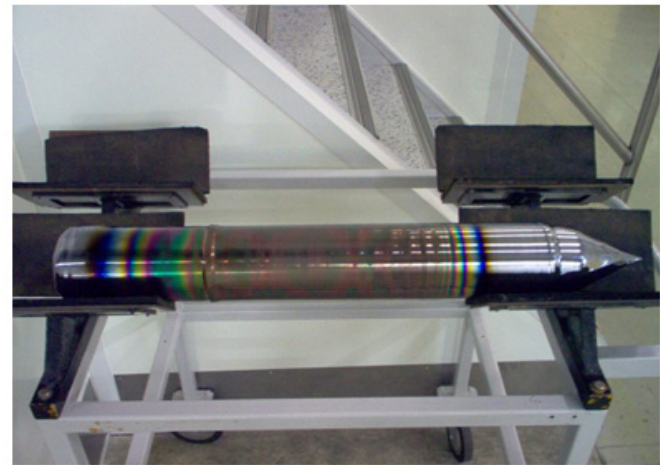
Principles of CZ growth process

Images of the Czochralski method removed due to copyright restrictions.

Please see: http://semiconductor-nano.com/images/Czochralski_2a.gif

http://semiconductor-nano.com/images/Czochralski_2c.gif

http://people.seas.harvard.edu/~jones/es154/lectures/lecture_2/materials/Czochralski_1.gif.



Courtesy of A. A. Istratov. Used with permission.

Float-zone silicon growth

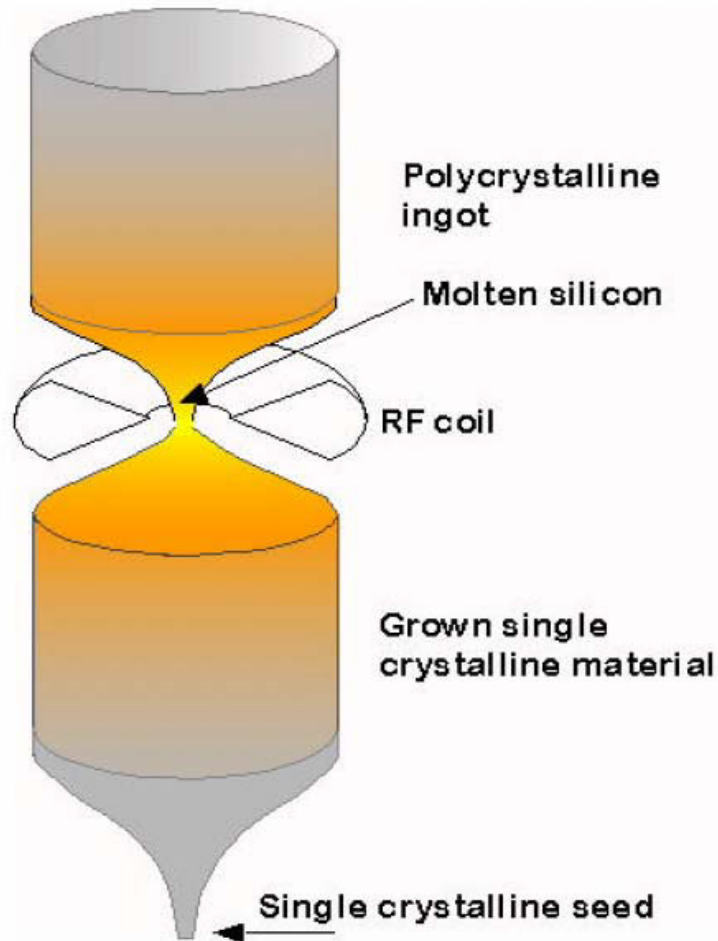


Image removed due to copyright restrictions.
Please see any photo of float zone silicon, such as
http://www2.epia.org/images/pho_profiles_A/pho_profiles_A_39.jpg.

Courtesy Christiana Honsberg and Stuart Bowden. Used with permission.

Crystal grows without contact with crucible and has the lowest possible impurity content (particularly low oxygen and carbon content). However, FZ growth appears to be more expensive than CZ growth and is used only for the most demanding applications.

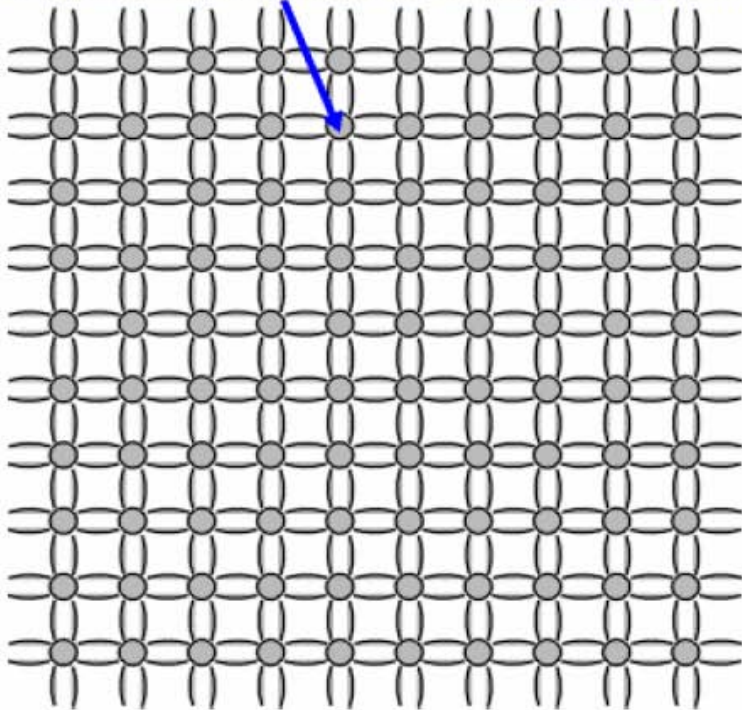
Courtesy of A. A. Istratov. Used with permission.

Crystalline silicon

Single crystalline silicon

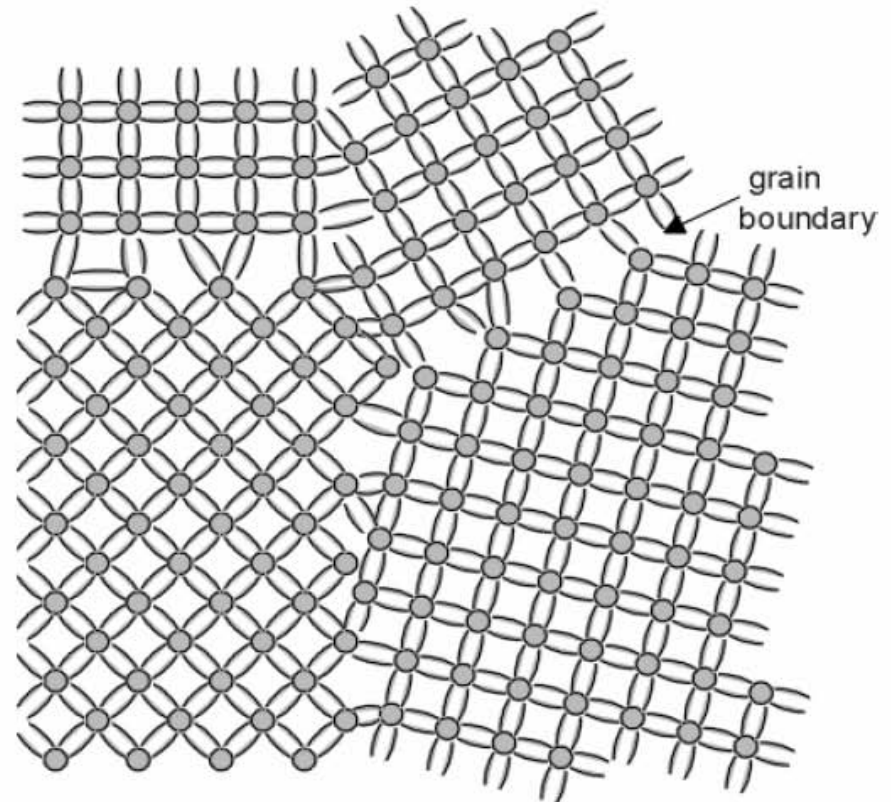
FZ, CZ

Each silicon atom is bonded to four neighbouring atoms.



Multicrystalline silicon

Cast, ribbon, sheet techniques



The grain size in multicrystalline silicon is from several microns to several millimeters or even centimeters. The fundamental physical properties such as bandgap and absorption properties are similar. The difference between c-Si and mc-Si is primarily the density of defects and impurities – and **cost, cost, cost**.

Multicrystalline silicon is very easy to distinguish from single crystalline silicon:

grains in mc-Si are clearly visible in reflected light



*Single-crystalline
CZ or FZ wafer*

Image removed due to copyright restrictions.
Please see any image of polycrystalline silicon, such as
http://commons.wikimedia.org/wiki/File:Multicrystallinewafer_0001.jpg.

Multicrystalline silicon wafer

Casting/directional solidification of mc-silicon



Mainstream multicrystalline silicon technology

Image removed due to copyright restrictions.
Please see <http://siliconsultant.com/images/DScasting.gif>.

Silicon can be solidified either in a separate crucible after it is poured from a melting crucible, or can be melted and directionally solidified in the same crucible. Crucibles are usually made of quartz or graphite, often with Si_3N_4 coating.

240 kg ingots with cross-section of 69x69 cm are grown in total cycle times of 56 hours.

Drawing from www.siliconsultant.com, Ted Ciszek

Courtesy of A. A. Istratov. Used with permission.

Casting of multicrystalline silicon

Images removed due to copyright restrictions.

Please see any photos of multicrystalline silicon ingots and blocks, such as

http://www.tkx.co.jp/english/solar/images/index_img_03.jpg

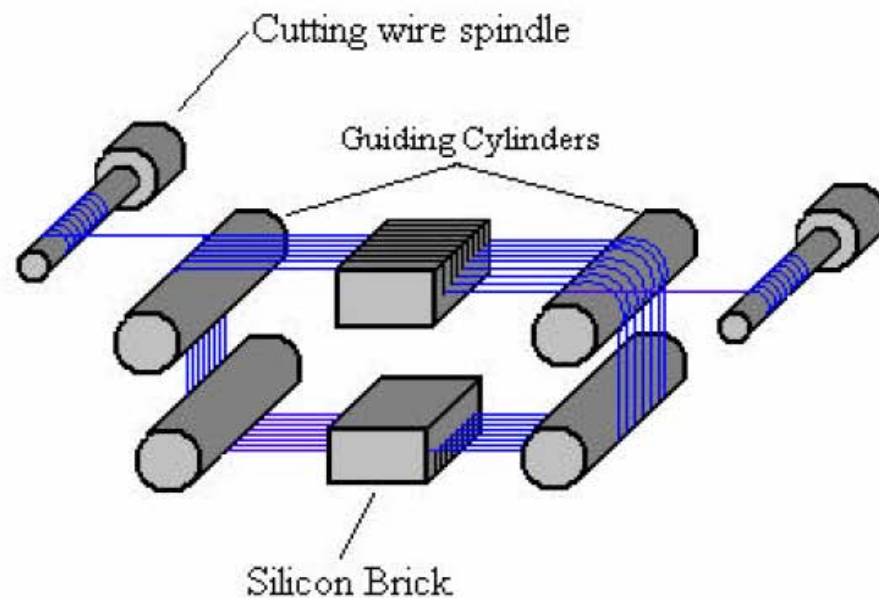
http://www.tkx.co.jp/english/solar/images/index_img_05.jpg.

Ingots are initially cut into rectangular blocks, and then sliced into wafers. Ingots can weigh up to 200-250 kg. The major part of mc-Si used in PV is grown by casting.

Courtesy of A. A. Istratov. Used with permission.

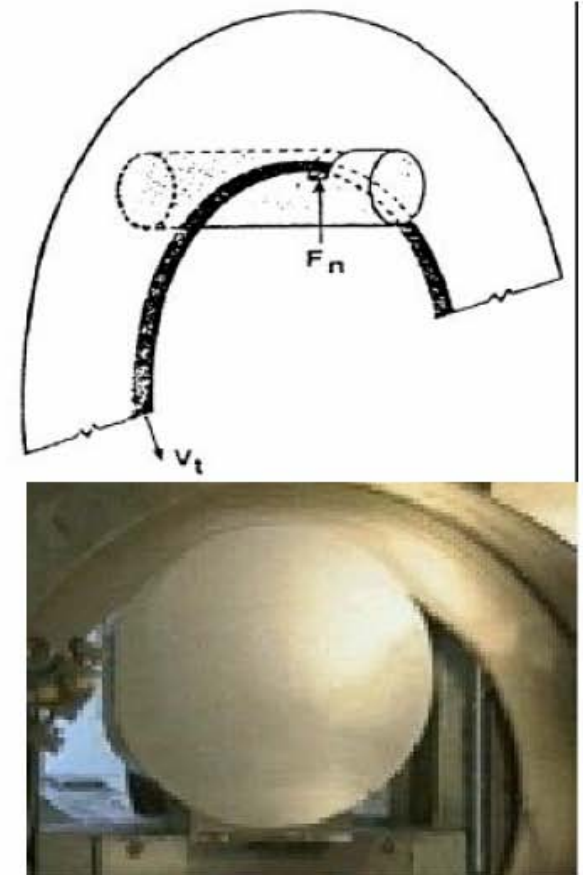
Wafering (cutting ingots into wafers)

Possible configuration of a wire saw



Abrasive wire length may be up to several km.

Inner diameter slicing



Kerf loss during sawing is typically 30-40% of silicon

Courtesy of A. A. Istratov. Used with permission.

Ribbon growth (A)

EFG (Edge-Defined, Film-Fed Growth) – RWE Schott Solar

Image removed due to copyright restrictions.

Please see Fig. 2 in Bell, R. O., and J. P. Kalejs. "Growth of Silicon Sheets for Photovoltaic Applications."
Journal of Materials Research 13 (October 1998): 2732-2739.

Growth rate: 1-3 cm/min

No sawing required!

Courtesy of A. A. Istratov. Used with permission.

Ribbon growth (B)

String ribbon growth technique - Evergreen Solar

E. Sachs, *J. Cryst. Growth* **82** (1987) 117

Similar technique:

T.F.Ciszek and J.L.Hurd, 1980

Edge-supported pulling

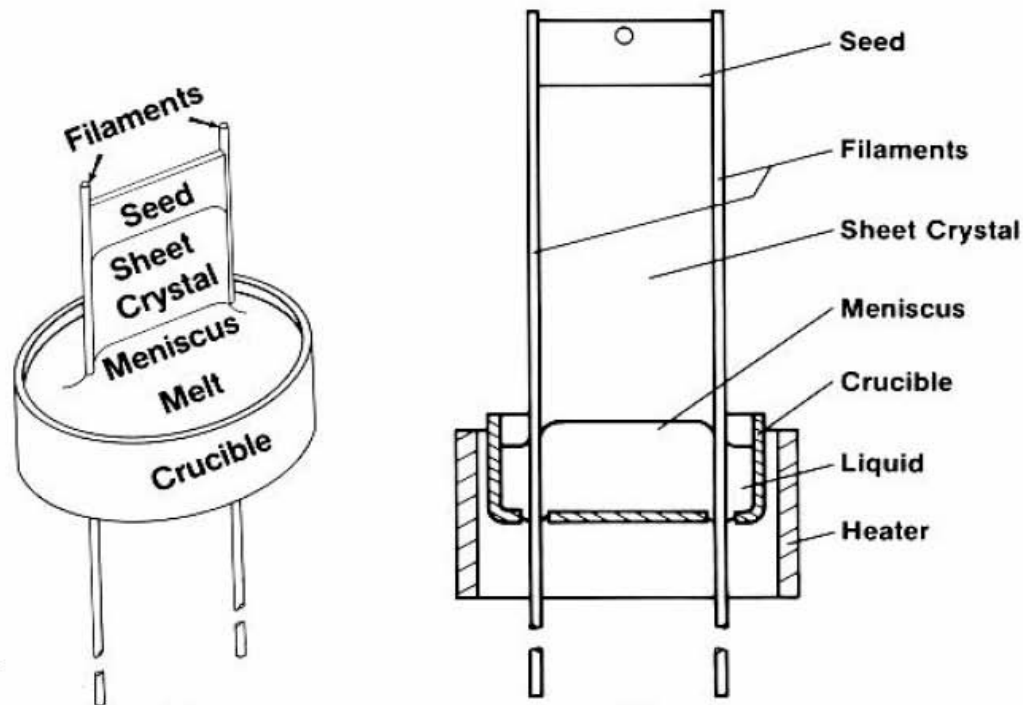
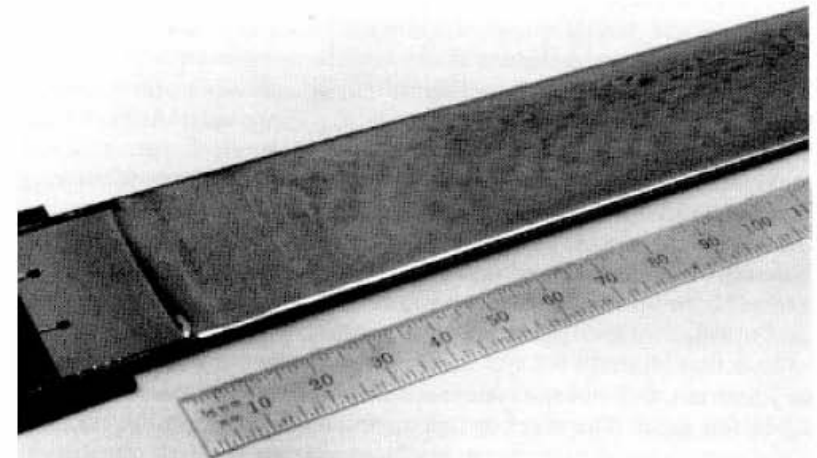


Image removed due to copyright restrictions.

Please see <http://siliconsultant.com/images/Espphoto.jpg>.

Fig. 5. Hot-zone region for growth of ESP ribbons.



g. 6. Silicon sheet grown by edge-supported pulling using rigid graphite filaments.

Courtesy of Elsevier, Inc., <http://www.sciencedirect.com>.
Used with permission.

A good source of information on the basics:
T.F.Ciszek, *J.Cryst.Growth* 66, 655 (1984).

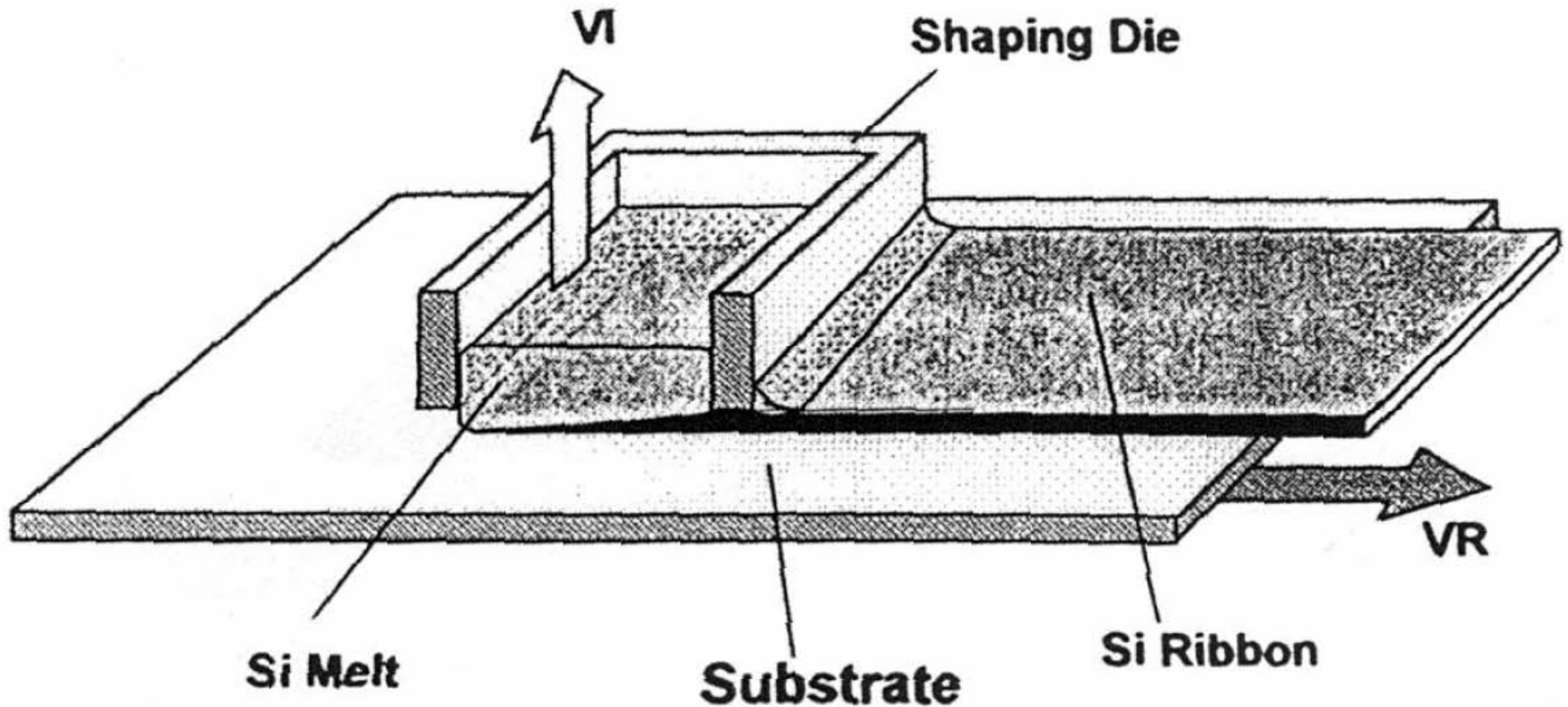
Growth rate: 1-3 cm/min

Courtesy of A. A. Istratov. Used with permission.

Courtesy of Elsevier, Inc., <http://www.sciencedirect.com>.
Used with permission.

Sheet Growth (A)

RGS (Ribbon Grown on Substrate) – ENC



Schematic of RGS growth system

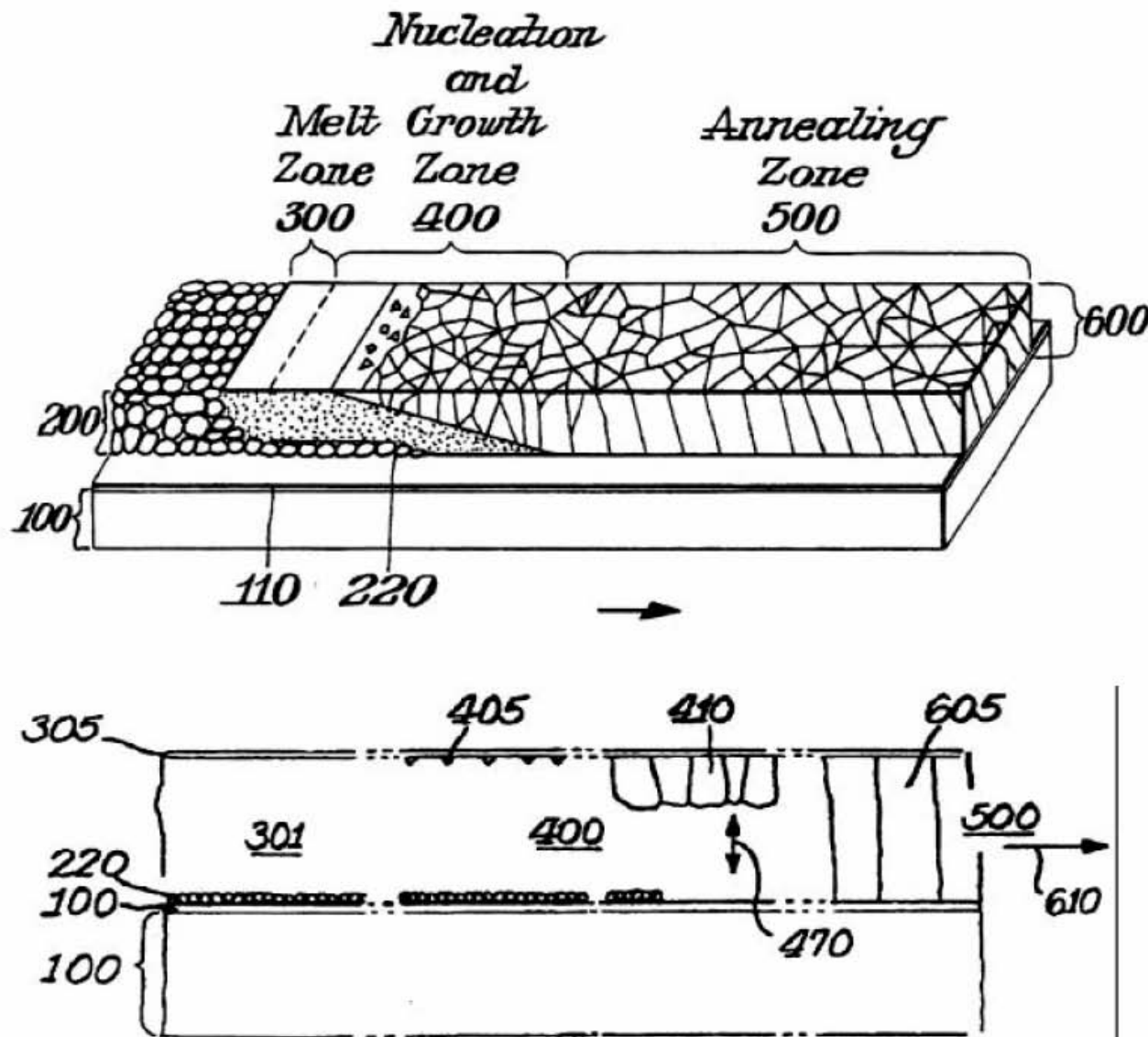
Courtesy of Elsevier, Inc., <http://www.sciencedirect.com>.
Used with permission.

Growth rates from 4 to 9 meters/min

Courtesy of A. A. Istratov. Used with permission.

Sheet Growth (B)

Sheet ribbon – General Electric (former Astropower)



100 – setter material
(a rigid board or a flexible thin belt made of, e.g., quartz graphite, silicon nitride, silicon carbide).

110 – release agent coating, e.g., silicon nitride, silicon oxynitride, silicon carbide, etc.

200 – granulated silicon, grain size: 20 to 1000 microns.

300 – melt zone in Ar/H mixture ambient to minimize Si oxidation

400 – controlled solidification and columnar growth from the top. Nucleation of grains is enhanced by addition of the “coating materials”, 305, which can be silicon carbides, nitrides, oxides,...

U.S. Patent 6,111,191 (August 2000)

Comparison of different growth techniques used in silicon technology

Method	Width (cm)	Growth rate, mm/min	Throughput (m ² /day)	Energy use (kWh/m ²)	Typical, best efficiency
Float zone	15	2-4	80	36	<18%, 24%
Czochralski	15	0.6-1.2	30	21-48	<17%, >20%
Cast – directional solidification	69	0.1-0.6	70	9-17	<16.5%, 20%
Ribbon Silicon	8-80 cm	15-20	20	20	15.5%, 18%
Sheet growth (substrate melt shaping)	20	1000-6000	>1000	No data	<12%, 16%

Courtesy of A. A. Istratov. Used with permission.

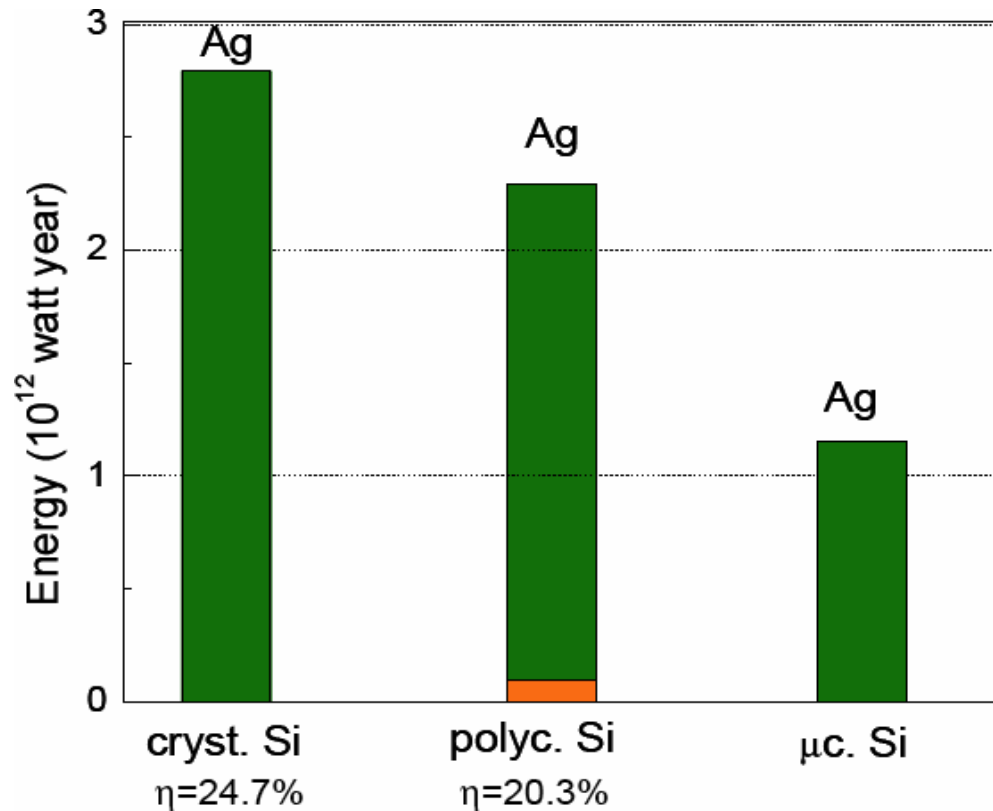
Source for efficiency values: M.A. Green *et al.*, *Solar Cell Efficiency Tables, Progress in Photovoltaics*.

Source for energy use, growth rate, etc.: www.siliconsultant.com . Disclaimer: These numbers are outdated, and may not reflect actual commercial production values.

Materials Availability

Plenty of (oxidized) silicon in the Earth's crust, but...

Not enough silver! New solar cell contact materials needed.



Source: Feltrin, A., A. Freundlich. "Material Considerations for Terawatt. Level Deployment of Photovoltaics." *Renewable Energy* 33 (2008): 180-185. Courtesy of Alex Freundlich. Used with permission.

Next Class

- *From wafers to cells.*
- *Intro to thin film technology.*